

FFPF15U40S

Features

- Ultrafast with soft recovery
- Low forward voltage

Applications

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply





1. Cathode 2. Anode

ULTRA FAST RECOVERY RECTIFIER

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Peak Repetitive Reverse Voltage	400	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	15	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	150	Α
T _{J,} T _{STG}	Operating Junction and StorageTemperature	- 65 to +150	°C

Thermal Characteristics

Symbol	Symbol Parameter		Units	
Reac	Maximum Thermal Resistance, Junction to Case	3.0	°C/W	

Electrical Characteristics T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage		25- 16		Tar Will	V
	I _F = 15A	$T_C = 25 ^{\circ}C$		- 4	1.4	
	I _F = 15A	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		-	1.3	
I _{RM} *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V _R	$T_C = 25 ^{\circ}C$	-	-	40	
	TO THE COM	$T_C = 25$ °C $T_C = 100$ °C	-	-	400	
t _{rr}	Maximum Reverse Recovery Time		-	-	50	ns
rr	Maximum Reverse Recovery Current		-	-	5.0	Α
Q _{rr}	Maximum Reverse Recovery Charge (I _F =15A, di/dt = 200A/μs)		-	-	125	nC
W _{AVL}	Avalanche Energy		1.0	-	-	mJ

^{*} Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Typical Characteristics

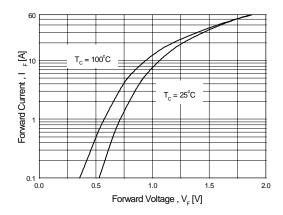


Figure 1. Typical Forward Voltage Drop vs. Forward Current

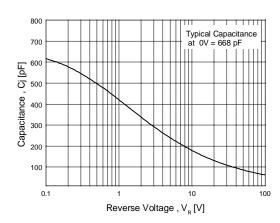


Figure 3. Typical Junction Capacitance

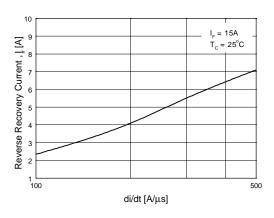


Figure 5. Typical Reverse Recovery Current vs. di/dt

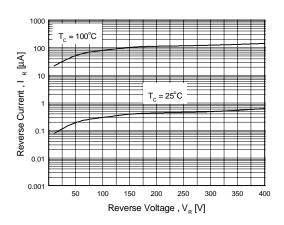


Figure 2. Typical Reverse Current vs. Reverse Voltage

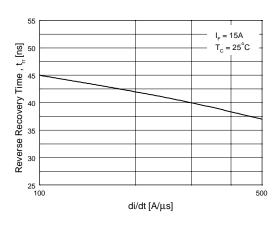


Figure 4. Typical Reverse Recovery Time vs. di/dt

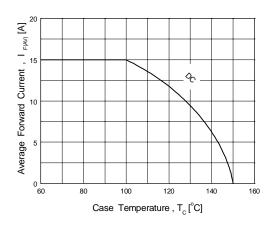
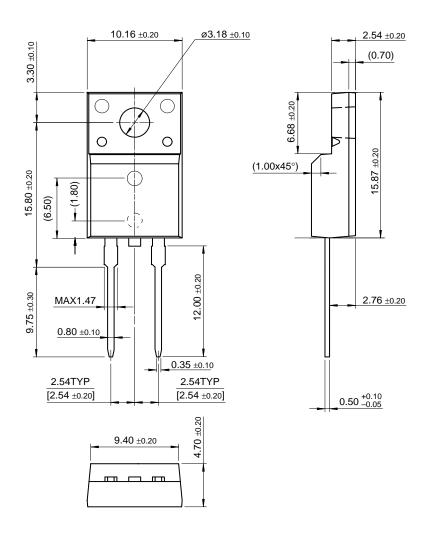


Figure 6. Forward Current Derating Curve

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Package Dimensions

TO-220F 2L



Dimensions in Millimeters

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